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initiates the compound (B) to under go a ring-opening polymerization; and

irradiating the sheet-form, curable pressure sensitive adhesive with an ultraviolet light having an intensity greater than 1 mW/cm² in a wavelength range exceeding 300 nm, either before or after said one member is adhered to another member via the sheet-form, curable pressure-sensitive adhesive.



- 14. (New) The method according to claim 12, wherein said high molecular weight polymer (A) is an acrylic polymer.
- 15. (New) The method according to claim 12, wherein said composition comprises 100 parts by weight of an acrylic polymer (A), 1 - 1000 parts by weight of the compound (B) and 0.01 - 1000 parts by weight of the polymerization initiator (C).
- 16. (New) The method according to claim 12, wherein the acrylic polymer (A) is a copolymer obtainable by copolymerizing a compound (a) containing at least one (meth)acryloyl group and at least one hydroxyl group per molecule with a copolymerizable monomer (b) which is copolymerizable with the compound (a).
- 17. (New) The method according to claim 16, wherein said compound (a) is at least one selected from the group consisting of the following compounds (1) through (10):

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[Compound 1]

 $CH_2=CH^*C(0)O^*CH_2CH_2O^*[C(0)CH_2CH_2CH_2CH_2CH_2C]n^*H$ (n=1-10)

[Compound 2]

 $CH_2=C(CH_3) \cdot C(O)O \cdot CH_2CH_2O \cdot [C(O)CH_2CH_2CH_2CH_2CH_2CH_2O] n \cdot H \quad (n=1-10)$

[Compound 3]

 $CH_2=CH^{\circ}C(0)O^{\circ}(CH_2CH_2O)n^{\circ}H (n=1-12)$

[Compound 4]

 $CH_2=C(CH_3) \cdot C(O)O \cdot (CH_2CH_2O)n \cdot H (n=1-12)$

[Compound 5]

 $CH_2=CH^*C(0)0^*[CH_2CH(CH_3)0]n^*H (n=1-12)$

[Compound 6]

 $CH_2=C(CH_3) \cdot C(O)O \cdot [CH_2CH(CH_3)O]n \cdot H (n=1-12)$

[Compound 7]

CH₂=C(CH₃)*C(O)O*(CH₂CH₂O)n*[CH₂CH(CH₃)O]m*H

(n=1-12, m=1-10)

[Compound 8]

 $CH_2=CH^{\circ}C(0)O^{\circ}(CH_2CH_2O)n^{\circ}[CH_2CH(CH_3)O]m^{\circ}H (n=1-12, m=1-10)$

[Compound 9]

 $CH_2=C(CH_3) \cdot C(O)O \cdot (CH_2CH_2O)n \cdot (CH_2CH_2CH_2CH_2O)mH$

(n=1-12, m=1-10)

[Compound 10]

 $CH_2=CH^{\bullet}C(O)O^{\bullet}(CH_2CH_2O)n^{\bullet}(CH_2CH_2CH_2CH_2CH_2O)mH$ (n=1-12, m=1-10)

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18. (New) The method according to claim 16, wherein said copolymerizable monomer (b) is selected from the group consisting of methyl (meth)acrylate, ethyl (meth)acrylate, cyclohexyl (meth)acrylate, benzyl (meth)acrylate and (meth)acrylic acid ester of alcohols containing a C-O-C ether bond.

- 19. (New) The method according to claim 12, wherein said polymerization initiator (C) is a cationic photopolymerization initiator.
- 20. (New) The method according to claim 19, wherein said cationic photopolymerization initiator is an onium salt compound.
- 21. (New) The method according to claim 12, wherein said composition further comprises a vinyl ether compound.
- 22. (New) The sheet-form, curable pressure-sensitive adhesive in accordance with claim 21, said composition includes 1 30 parts by weight of the vinyl ether compound relative to 30 70 parts by weight of the compound (B).